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SCAS692F-APRIL 2003-REVISED APRIL 2007

#### **FEATURES**

- Controlled Baseline
  - One Assembly/Test Site, One Fabrication Site
- Extended Temperature Performance of up to -40°C to 85°C, -40°C to 125°C and -55°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- Member of the Texas Instruments Widebus™
   Family
- State-of-the-Art Advanced BiCMOS
   Technology (ABT) Design for 3.3-V Operation
   and Low Static-Power Dissipation
- Supports Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V<sub>CC</sub>)
- Supports Unregulated Battery Operation Down to 2.7 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) <0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- I<sub>off</sub> and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

#### 48 20E 10E 1Y1 **1**2 47∏ 1A1 1Y2 🛮 3 46 🛛 1A2 GND [ 45 ¶ GND 1Y3 **∏** 5 44**∏** 1A3 1Y4 **∏**6 43 1A4 42 V<sub>CC</sub> $V_{CC}$ 8 41 2A1 2Y1 2Y2 **9** 40 🛮 2A2 GND 110 39 | GND 38 🛮 2A3 2Y3 🛮 11 2Y4 112 37 **□** 2A4 3Y1 113 36 🛮 3A1 3Y2 [ 14 35 3A2 GND 15 34 GND 33 A3 3Y3 **∏** 16 3Ү4 П 17 32**∏** 3A4 18 31 V<sub>CC</sub> $V_{CC}$ **1**19 4Y1 30 4A1

4Y2 20

GND ∏21

4Y3 **1**22

4Y4 [ 23

24

4<del>OE</del> [

29 **1** 4A2

28∏ GND

27**∏** 4A3

26 **4**A4

25 🛮 3<del>0E</del>

DGG, DGV, OR DL PACKAGE

(TOP VIEW)

## DESCRIPTION/ORDERING INFORMATION

The SN74LVTH16244A is a 16-bit buffer and line driver designed for low-voltage (3.3 V)  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment. This device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. This device provides true outputs and symmetrical active-low output-enable  $(\overline{OE})$  inputs.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments.

## SN74LVTH16244A-EP 3.3-V ABT 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

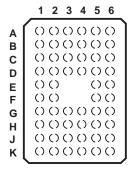
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When  $V_{CC}$  is between 0 V and 1.5 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

# GQL OR ZQL PACKAGE (TOP VIEW)



# TERMINAL ASSIGNMENTS<sup>(1)</sup> (56-Ball GQL/ZQL Package)

|   | 1               | 2   | 3               | 4               | 5   | 6               |
|---|-----------------|-----|-----------------|-----------------|-----|-----------------|
| Α | 1 <del>OE</del> | NC  | NC              | NC              | NC  | 2 <del>OE</del> |
| В | 1Y2             | 1Y1 | GND             | GND             | 1A1 | 1A2             |
| С | 1Y4             | 1Y3 | V <sub>CC</sub> | V <sub>CC</sub> | 1A3 | 1A4             |
| D | 2Y2             | 2Y1 | GND             | GND             | 2A1 | 2A2             |
| Е | 2Y4             | 2Y3 |                 |                 | 2A3 | 2A4             |
| F | 3Y1             | 3Y2 |                 |                 | 3A2 | 3A1             |
| G | 3Y3             | 3Y4 | GND             | GND             | 3A4 | 3A3             |
| Н | 4Y1             | 4Y2 | V <sub>CC</sub> | V <sub>CC</sub> | 4A2 | 4A1             |
| L | 4Y3             | 4Y4 | GND             | GND             | 4A4 | 4A3             |
| K | 4 <del>OE</del> | NC  | NC              | NC              | NC  | 3 <del>OE</del> |

(1) NC - No internal connection

#### ORDERING INFORMATION(1)

| T <sub>A</sub> | PACKAGE                     | (2)           | ORDERABLE PART NUMBER | TOP-SIDE MARKING |  |  |
|----------------|-----------------------------|---------------|-----------------------|------------------|--|--|
| -40°C to 125°C | SSOP - DL                   | Tape and reel | CLVTH16244AQDLREP     | LH16244AEP       |  |  |
|                | TSSOP - DGG                 | Tape and reel | CLVTH16244AQDGGREP    | LH16244AEP       |  |  |
|                | TVSOP - DGV                 | Tape and reel | CLVTH16244AIDGVREP    | LL244AEP         |  |  |
| –40°C to 85°C  | VFBGA – GQL                 | Tone and real | CLVTH162244AIGQLREP   | LL 244AED        |  |  |
|                | VFBGA – ZQL (Pb-free)       | Tape and reel | CLVTH16244AIZQLREP    | LL244AEP         |  |  |
| –55°C to 125°C | C TSSOP – DGG Tape and reel |               | CLVTH16244AMDGGREP    | H16244AMEP       |  |  |

<sup>(1)</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

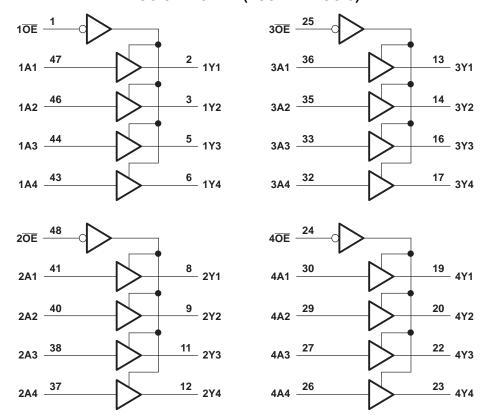
<sup>(2)</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



# FUNCTION TABLE (each 4-bit buffer)

| INP | JTS | OUTPUT |
|-----|-----|--------|
| ŌĒ  | Α   | Y      |
| L   | Н   | Н      |
| L   | L   | L      |
| Н   | X   | Z      |

## **LOGIC DIAGRAM (POSITIVE LOGIC)**



Pin numbers shown are for the DGG, DGV, and DL packages.

## SN74LVTH16244A-EP 3.3-V ABT 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

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## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |   |   | MIN                   | MAX | UNIT |  |
|------------------|---|---|-----------------------|-----|------|--|
| $V_{CC}$         | Supply voltage range                                  |   | -0.5                  | 4.6 | V    |  |
| VI               | Input voltage range (2)                               |   | -0.5                  | 7   | V    |  |
| Vo               | Voltage range applied to any output in the high-impe  | dance or power-off state <sup>(2)</sup> | -0.5                  | 7   | V    |  |
| Vo               | Voltage range applied to any output in the high state | -0.5                                    | V <sub>CC</sub> + 0.5 | V   |      |  |
|                  | Ourselists and advantisation law state                | SN74LVTH16244AQ                         |                       | 96  | 1    |  |
| IO               | Current into any output in the low state              | SN74LVTH16244AI                         |                       | 128 | mA   |  |
|                  | Occupation and the bight state (3)                    | SN74LVTH16244AQ                         |                       | 48  | 0    |  |
| IO               | Current into any output in the high state (3)         | SN74LVTH16244AI                         |                       | 64  | mA   |  |
| I <sub>IK</sub>  | Input clamp current                                   | V <sub>I</sub> < 0                      |                       | -50 | mA   |  |
| I <sub>OK</sub>  | Output clamp current                                  | V <sub>O</sub> < 0                      |                       | -50 | mA   |  |
|                  |   | DGG package                             |                       | 70  |      |  |
| 0                | Decline the arread increased as a (4)                 | DGV package                             |                       | 58  | 0000 |  |
| $\theta_{JA}$    | Package thermal impedance (4)                         | DL package                              |                       | 63  | °C/W |  |
|                  |   | GQL/ZQL package                         |                       | 42  |      |  |
| T <sub>stg</sub> | Storage temperature range                             |   | -65                   | 150 | °C   |  |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## Recommended Operating Conditions<sup>(1)</sup>

|                          |                                    |                 | MIN | MAX | UNIT |
|--------------------------|------------------------------------|-----------------|-----|-----|------|
| V <sub>CC</sub>          | Supply voltage                     |                 | 2.7 | 3.6 | V    |
| V <sub>IH</sub>          | High-level input voltage           |                 | 2   |     | V    |
| V <sub>IL</sub>          | Low-level input voltage            |                 | 0.8 | V   |      |
| VI                       | Input voltage                      |                 |     | 5.5 | V    |
|                          |                                    | SN74LVTH16244AQ |     | -24 |      |
| I <sub>OH</sub>          | High-level output current          | SN74LVTH16244AI |     | -32 | mA   |
|                          |                                    | SN74LVTH16244AM |     | -24 |      |
|                          |                                    | SN74LVTH16244AQ |     | 24  |      |
| I <sub>OL</sub>          | Low-level output current           | SN74LVTH16244AI |     | 64  | mA   |
|                          |                                    | SN74LVTH16244AM |     | 24  |      |
| Δt/Δν                    | Input transition rise or fall rate | Outputs enabled |     | 10  | ns/V |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate                 | ·               | 200 |     | μs/V |
|                          |                                    | SN74LVTH16244AQ | -40 | 125 |      |
| T <sub>A</sub>           | Operating free-air temperature     | SN74LVTH16244AI | -40 | 85  | °C   |
|                          |                                    | SN74LVTH16244AM | -55 | 125 |      |

<sup>(1)</sup> All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

 <sup>(2)</sup> The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 (3) This current flows only when the output is in the high state and V<sub>O</sub> > V<sub>CC</sub>.
 (4) The package thermal impedance is calculated in accordance with JESD 51-7.





## **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

| PAR                             | AMETER    | TEST COND  | ITIONS           | V <sub>cc</sub>      | MIN                   | TYP <sup>(1)</sup> MAX | UNIT  |
|---------------------------------|-----------|--|------------------|----------------------|-----------------------|------------------------|-------|
| V <sub>IK</sub>                 |           | I <sub>I</sub> = -18 mA  |                  | 2.7 V                |                       | -1.2                   | 2 V   |
|                                 |           | $I_{OH} = -100  \mu A$   |                  | 2.7 V to 3.6 V       | V <sub>CC</sub> - 0.2 |                        |       |
|                                 |           | $I_{OH} = -8 \text{ mA}$   |                  | 2.7 V                | 2.4                   |                        |       |
|                                 |           |  | 'LVTH16244AQ     |                      | 2                     |                        |       |
|                                 |           | I <sub>OH</sub> = -24 mA   | 'LVTH16244AI     |                      |                       |                        |       |
| V <sub>OH</sub>                 |           |  | 'LVTH16244AM     | 0.17                 | 2                     |                        | V     |
|                                 |           |  | 'LVTH16244AQ     | 3 V                  |                       |                        |       |
|                                 |           | $I_{OH} = -32 \text{ mA}$  | 'LVTH16244AI     |                      | 2                     |                        |       |
|                                 |           |  | 'LVTH16244AM     |                      |                       |                        |       |
|                                 |           | I <sub>OL</sub> = 100 μA   |                  |                      |                       | 0.2                    | 2     |
|                                 |           | I <sub>OL</sub> = 24 mA  |                  | 2.7 V                |                       | 0.0                    | 5     |
|                                 |           | I <sub>OL</sub> = 16 mA  |                  |                      |                       | 0.4                    | 1     |
|                                 |           |  | 'LVTH16244AQ     |                      |                       |                        |       |
| V <sub>OL</sub>                 |           | I <sub>OL</sub> = 32 mA  | 'LVTH16244AI     |                      |                       | 0.0                    | 5 V   |
|                                 |           |  | 'LVTH16244AM     | 3 V                  |                       |                        |       |
|                                 |           |  | 'LVTH16244AQ     |                      |                       |                        |       |
|                                 |           | I <sub>OL</sub> = 64 mA  | 'LVTH16244AI     |                      |                       | 0.5                    | 5     |
|                                 |           |  | 'LVTH16244AM     |                      |                       |                        |       |
|                                 |           |  | 'LVTH16244AQ     |                      |                       | 50                     | )     |
|                                 |           | V <sub>I</sub> = 5.5 V   | 'LVTH16244AI     | 0 V or 3.6 V         |                       | 10                     | )     |
|                                 | ı Control |  | 'LVTH16244AM     |                      |                       | 50                     | )     |
| I <sub>I</sub>                  |           | $V_I = V_{CC}$ or GND  |                  |                      |                       | ±                      | μΑ    |
|                                 | inputs    |  |                  | 3.6 V                |                       |                        | !<br> |
|                                 | Data      | $V_I = V_{CC}$   |                  | 3.0 V                |                       |                        | l     |
|                                 | inputs    | V <sub>I</sub> = 0 V   | T                |                      |                       |                        | 5     |
|                                 |           |  | 'LVTH16244AQ     | _                    |                       |                        |       |
| I <sub>off</sub>                |           | $V_I$ or $V_O = 0 V$ to 4.5 V  | 'LVTH16244AI     | 0 V                  |                       | ±100                   | ) μΑ  |
|                                 | 1         |  | 'LVTH16244AM     |                      |                       |                        |       |
|                                 |           | V <sub>I</sub> = 0.8 V   |                  | 3 V                  | 75                    |                        |       |
|                                 |           | V <sub>I</sub> = 2 V   | T                |                      | -75                   |                        |       |
| I <sub>I(hold)</sub>            | Data      |  | 'LVTH16244AQ     |                      |                       |                        | μΑ    |
| ( /                             | inputs    | $V_1 = 0 \text{ V to } 3.6 \text{ V}$  | 'LVTH16244AI     | 3.6 V <sup>(2)</sup> |                       | 500<br>-750            |       |
|                                 |           |  | 'LVTH16244AM     | -                    |                       | -750                   | _     |
| la=::                           |           | V <sub>O</sub> = 3 V   | LVIIII0244AIVI   | 3.6 V                |                       |                        | 5 μΑ  |
| I <sub>OZH</sub>                |           | V <sub>O</sub> = 3 V<br>V <sub>O</sub> = 0.5 V                                     |                  | 3.6 V                |                       | <u>`</u><br>           | •     |
| I <sub>OZL</sub>                |           | $V_O = 0.5 \text{ V}$<br>$V_O = 0.5 \text{ V to 3 V}, \overline{OE} = \text{Don'}$ | t care           | 0 V to 1.5 V         |                       | ±100                   |       |
| I <sub>OZPU</sub>               |           | $V_0 = 0.5 \text{ V to 3 V, } \overline{\text{OE}} = \overline{\text{Don'}}$       |                  | 1.5 V to 0 V         |                       | ±100                   |       |
| l <sub>OZPD</sub>               |           | V <sub>O</sub> = 0.5 V to 5 V, OL = Doll   | Outputs high     | 1.5 V 10 0 V         |                       | 0.19                   | •     |
| loo                             |           | $I_{O} = 0$ ,  | Outputs low      | 3.6 V                |                       |                        | 5 mA  |
| I <sub>CC</sub>                 |           | $V_I = V_{CC}$ or GND  | Outputs disabled | - 0.5 v              |                       | 0.19                   |       |
| Δl <sub>CC</sub> <sup>(3)</sup> |           | One input at V <sub>CC</sub> – 0.6 V,  | Outputs disabled | 3 V to 3.6 V         | 0.2                   | 0.18                   |       |
|                                 |           | Other inputs at V <sub>CC</sub> or GND   |                  |                      | -                     |                        |       |
| $C_{i}$                         |           | $V_I = 3 V \text{ or } 0 V$  |                  |                      |                       | 4                      | pF    |

<sup>(1)</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . (2) This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

<sup>(3)</sup> This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V<sub>CC</sub> or GND.

## SN74LVTH16244A-EP 3.3-V ABT 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

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## **Electrical Characteristics (continued)**

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS             | V <sub>cc</sub> | MIN | TYP <sup>(1)</sup> | MAX | UNIT |
|-----------|-----------------------------|-----------------|-----|--------------------|-----|------|
| Co        | V <sub>O</sub> = 3 V or 0 V |                 |     | 9                  |     | pF   |

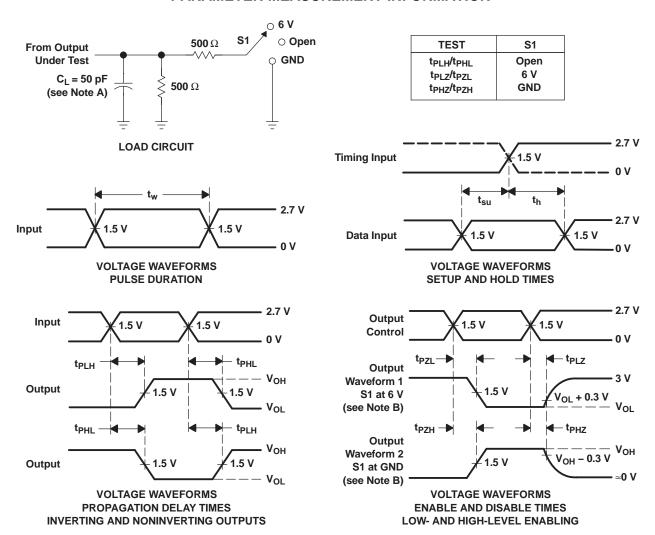
## **Switching Characteristics**

over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

|                    |                 | TO<br>(OUTPUT) | SN7                          | 74LVTH1 | 16244AQ                 | /M  |                              | SN74L | VTH162 | 244AI                   |     |      |
|--------------------|-----------------|----------------|------------------------------|---------|-------------------------|-----|------------------------------|-------|--------|-------------------------|-----|------|
| PARAMETER          | FROM<br>(INPUT) |                | $V_{CC}$ = 3.3 V $\pm$ 0.3 V |         | V <sub>CC</sub> = 2.7 V |     | $V_{CC}$ = 3.3 V $\pm$ 0.3 V |       |        | V <sub>CC</sub> = 2.7 V |     | UNIT |
|                    |                 |                | MIN                          | MAX     | MIN                     | MAX | MIN                          | TYP   | MAX    | MIN                     | MAX |      |
| t <sub>PLH</sub>   | Α               |                | 1.1                          | 4.4     |                         | 4.6 | 1.2                          | 2.5   | 3.2    |                         | 3.7 | ns   |
| t <sub>PHL</sub>   | A               | ľ              | 1.1                          | 3.6     |                         | 3.9 | 1.2                          | 2     | 3.2    |                         | 3.7 | 113  |
| t <sub>PZH</sub>   | ŌĒ              | Y              | 1.1                          | 4.6     |                         | 5.4 | 1.2                          | 2.6   | 4      |                         | 5   | ne   |
| t <sub>PZL</sub>   | OE              | Y              | 1.1                          | 5.4     |                         | 6.2 | 1.2                          | 2.7   | 4      |                         | 5   | ns   |
| t <sub>PHZ</sub>   | ŌĒ              |                | 1.6                          | 5.7     |                         | 6.2 | 2.2                          | 3.3   | 4.5    |                         | 5   | ns   |
| t <sub>PLZ</sub>   | OL              | T              | 1.2                          | 5       |                         | 4.7 | 2                            | 3.1   | 4.2    |                         | 4.4 | 115  |
| t <sub>sk(o)</sub> |                 |                |                              |         |                         |     |                              |       | 0.5    |                         |     | ns   |



#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O$  = 50  $\Omega$ ,  $t_r \leq$  2.5 ns.  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





10-Dec-2020

#### **PACKAGING INFORMATION**

| Orderable Device   | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5) | Samples |
|--------------------|--------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|----------------------|---------|
|                    | ( )    |              | _                  |      | -              | ( )          | (6)                           | (-)                |              | ( /                  |         |
| 8W244AMDGGREPG4    | ACTIVE | TSSOP        | DGG                | 48   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | H16244AMEP           | Samples |
| CLVTH16244AIDGVREP | ACTIVE | TVSOP        | DGV                | 48   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | LL244AEP             | Samples |
| CLVTH16244AMDGGREP | ACTIVE | TSSOP        | DGG                | 48   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | H16244AMEP           | Samples |
| CLVTH16244AQDGGREP | ACTIVE | TSSOP        | DGG                | 48   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LH16244AEP           | Samples |
| CLVTH16244AQDLREP  | ACTIVE | SSOP         | DL                 | 48   | 1000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LH16244AEP           | Samples |
| V62/04601-01XE     | ACTIVE | SSOP         | DL                 | 48   | 1000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LH16244AEP           | Samples |
| V62/04601-01YE     | ACTIVE | TSSOP        | DGG                | 48   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LH16244AEP           | Samples |
| V62/04601-02ZE     | ACTIVE | TVSOP        | DGV                | 48   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | LL244AEP             | Samples |
| V62/04601-03YE     | ACTIVE | TSSOP        | DGG                | 48   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | H16244AMEP           | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE**: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



## PACKAGE OPTION ADDENDUM

10-Dec-2020

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN74LVTH16244A-EP:

Catalog: SN74LVTH16244A

Military: SN54LVTH16244A

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

## **PACKAGE MATERIALS INFORMATION**

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## TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device             | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CLVTH16244AIDGVREP | TVSOP           | DGV                | 48 | 2000 | 330.0                    | 16.4                     | 7.1        | 10.2       | 1.6        | 12.0       | 16.0      | Q1               |
| CLVTH16244AMDGGREP | TSSOP           | DGG                | 48 | 2000 | 330.0                    | 24.4                     | 8.6        | 13.0       | 1.8        | 12.0       | 24.0      | Q1               |
| CLVTH16244AQDGGREP | TSSOP           | DGG                | 48 | 2000 | 330.0                    | 24.4                     | 8.6        | 13.0       | 1.8        | 12.0       | 24.0      | Q1               |
| CLVTH16244AQDLREP  | SSOP            | DL                 | 48 | 1000 | 330.0                    | 32.4                     | 11.35      | 16.2       | 3.1        | 16.0       | 32.0      | Q1               |

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### \*All dimensions are nominal

| 7 til dillionolono dio monimal |              |                 |      |      |             |            |             |
|--------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| CLVTH16244AIDGVREP             | TVSOP        | DGV             | 48   | 2000 | 356.0       | 356.0      | 35.0        |
| CLVTH16244AMDGGREP             | TSSOP        | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| CLVTH16244AQDGGREP             | TSSOP        | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| CLVTH16244AQDLREP              | SSOP         | DL              | 48   | 1000 | 367.0       | 367.0      | 55.0        |

# DL (R-PDSO-G48)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.





SMALL OUTLINE PACKAGE



### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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